

Testpoints

Type: CTP

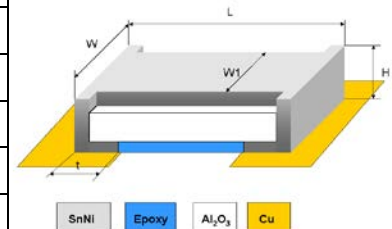
Sizes: 0603, 0805, 1206, 1210, 1218, 2010, 2512

Characteristics:

- RoHS-conform and Halogen-free according to IEC 61249-2-21 / IPC 4101B
- Customer specific barcodes available - also in 2D
- All sizes can be manufactured with the following contact variants
⇒ Electroplated pure tin

Dimensions (in mm):

Size	L Length		W Width		W1 Width		H Depth		t Contact back	
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
0603	1,50	1,70	0,75	0,95	0,50	0,70	0,35	0,55	0,10	0,50
0805	1,85	2,15	1,10	1,40	0,80	1,10	0,35	0,65	0,15	0,60
1206	2,90	3,35	1,45	1,75	1,00	1,30	0,35	0,65	0,25	0,75
1210	3,00	3,30	2,35	2,65	0,50	0,75	0,35	0,85	0,35	0,85
1218	3,00	3,30	4,50	4,80	0,50	0,75	0,35	0,85	0,35	0,85
2010	4,80	5,20	2,30	2,70	0,50	0,75	0,35	0,85	0,35	0,85
2512	6,10	6,50	3,00	3,30	0,50	0,75	0,35	0,85	0,35	0,85



Packaging units:

Reel Ø	Card tape	Blister tape
	acc. EN 60286-3	
180 mm	5 T pcs.	4 T pcs.
330 mm	10 T pcs. 20 T pcs.	8 T pcs. 16 T pcs.
Samples on request		

Ordering information:

CTP	0805	P	5 (optional)
Type	Size	Packaging	pcs. / Reel (T pcs.)
CTP	0603 to 2512	P- Card tape B- Blister tape S- Bulk	Depends on size and packaging unit

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Technical data:

This test points, as well as other SMD elements, can be automatically loaded and allow control measurements on the finished board. The contact surface is coated with a solid, electroplated SnNi layer.

Technical data - general:

Technical data	
Solderability acc. EN 60068-2-58	245°C 3s
Soldering heat resistance acc. EN 60068-2-58	260°C 10s